

ART 1/2 MAINTENANCE NOTE 12 (for Electronics Technicians)
Engineering Division
W/OS0321: FLP

Master Control Unit (MCU) Packing Instructions

General

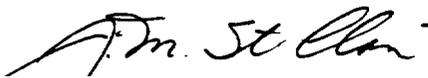
1. Maintenance Note 12 contains packing instructions for shipping the ART system MCU.
2. Effect on Other Instructions: None

Procedure

The National Reconditioning Center (NRC) has received several MCUs (J170-3A3) with cracked connectors on the +5 volt power supply. The damage occurs during shipping. Because the supply extends out of the MCU chassis, foam packing cannot provide adequate protection.

To prevent this damage, the MCU is shipped with the power supply packed separately and enclosed with the chassis. Use caution and do not overtighten the mounting hardware when installing the power supply. Applying too much tension will crack the connector.

Return the defective MCU with the power supply packed separately and enclosed with the chassis. Use the packing from the replacement unit. The MCU must be returned complete with the power supply.



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